

APT100DL60B(G) APT100DL60S(G) 600V 100A

*G Denotes RoHS Compliant, Pb Free Terminal Finish.

Ultrasoft Recovery Rectifier Diode

PRODUCT APPLICATIONS

- Anti-Parallel Diode
 -Switchmode Power Supply
 -Inverters
- Applications

 Induction Heating
- Resonant Mode Circuits
 -ZVS and ZCS Topologies
 Phase Shifted Bridge

PRODUCT FEATURES

- Ultrasoft Recovery Times (trr)
- Popular TO-247 Package or Surface Mount D³PAK Package
- Ultra Low Forward Voltage
- Low Leakage Current

PRODUCT BENEFITS

- Soft Switching High Q_{rr}
 Low Noise Switching
- Reduced Ringing
- Higher Reliability Systems
- Minimizes or eliminates
 snubber





^{1 -} Cathode 2 - Anode Back of Case - Cathode

MAXIMUM RATINGS

All Ratings: $T_{C} = 25^{\circ}C$ unless otherwise specified.

Symbol	Characteristic / Test Conditions	Ratings	Unit
V _R	Maximum D.C. Reverse Voltage		
V _{RRM}	Maximum Peak Repetitive Reverse Voltage	600	Volts
V _{RWM}	Maximum Working Peak Reverse Voltage		
I _{F(AV)}	Maximum Average Forward current ⁽¹⁾ ($T_c = 124$ °C, Duty Cycle = 0.5)	100	
I _{F(RMS)}	RMS Forward Currrent (Square wave, 50% duty)	131	Amps
I _{FSM}	Non-Repetitive Forward Surge Current (T _J = 45°C, 8.3 ms)	600	
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to 175	°C
TL	Lead Temperature for 10 Seconds	300	C

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		Min	Тур	Max	Unit
V _F	Forward Voltage	I _F = 100A		1.25	1.6	Volts
		I _F = 200A		2.0		
		I _F = 100A, T _J = 125°C		1.28		
I _{RM}	Maximum Reverse Leakage Current	V _R = 600V			25	μA
		V _R = 600V, T _J = 125°C			250	
C _T	Junction Capacitance, V _R = 200V			97		pF

DYNAMIC CHARACTERISTICS

APT100DL60B_S(G)

Symbol	Characteristic / Test Conditions		Min	Тур	Max	Unit
t _{rr}	Reverse Recovery Time $I_F = 1A$, $di_F/dt = -100A/\mu s$,	V _R = 30V, T _J = 25°C		45		20
t _{rr}	Reverse Recovery Time	I _F = 100A, di _F /dt = -200A/ μs V _R = 400V, T _C = 25°C		487		115
Q _{rr}	Reverse Recovery Charge			2328		nC
I _{RRM}	Maximum Reverse Recovery Current			11		Amps
t _{rr}	Reverse Recovery Time	I _F = 100A, di _F /dt = -200A/μs V _R = 400V, T _C = 125°C		716		ns
Q _{rr}	Reverse Recovery Charge			5954		nC
I _{RRM}	Maximum Reverse Recovery Current			18		Amps
t _{rr}	Reverse Recovery Time	I _F = 100A, di _F /dt = -1000A/ μs V _R = 400V, T _C = 125°C		333		ns
Q _{rr}	Reverse Recovery Charge			10002		nC
I _{RRM}	Maximum Reverse Recovery Current			49		Amps

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	Min	Тур	Мах	Unit
R _{ejc}	Junction-to-Case Thermal Resistance			0.34	°C/W
W _T	Package Weight		0.22		oz
			5.9		g
Torque	Maximum Mounting Torque			10	lb∙in
				1.1	N∙m

① Continuous current limited by package lead temperature.

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RECTANGULAR PULSE DURATION (seconds) FIGURE 1. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION



FIGURE 8, Junction Capacitance vs. Reverse Voltage



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= 125°C



FIGURE 7, Maximum Average Forward Current vs. Case Temperature







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